EVERLIGHT EVERLIGHT ELECTRONICS CO., LTD.

Technical Data Sheet

0805 Package Chip LED (0.8mm Height)

Features

- Package in 8mm tape on 7" diameter reel.
- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow

solder process.

- Mono-color type.
- Pb-free.
- The product itself will remain within RoHS compliant version

Descriptions

- The 17-215 SMD Taping is much smaller than lead frame type components, thus enable smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained.
- Besides, lightweight makes them ideal for miniature applications. etc.

Applications

- Telecommunication: indicator and backlighting in telephone and fax.
- Flat backlight for LCD, switch and symbol.
- General use.
- Indoor signboard use.

Device Selection Guide

Part No.	(
	Material	Emitted Color	Lens Color
17-215/GVC-ALMB/3T	AlGaInP	Green	Water Clear

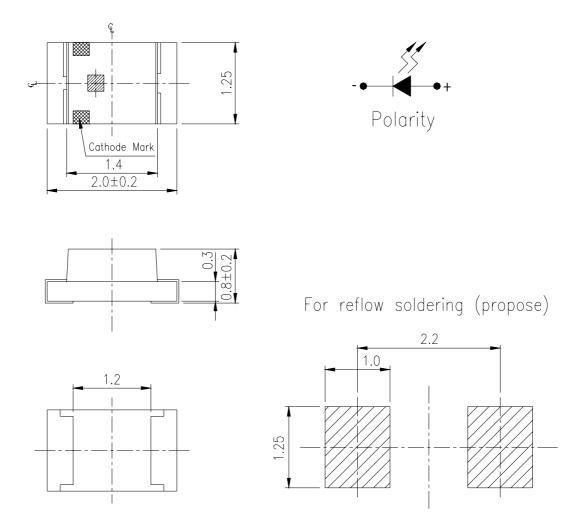


17-215/GVC-ALMB/3T



Package Outline Dimensions

17-215/GVC-ALMB/3T



Note: The tolerances unless mentioned are ± 0.1 mm ,Unit = mm

17-215/GVC-ALMB/3T

Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Rating	Unit	
Reverse Voltage	VR	5	V	
Forward Current	$\mathbf{I}_{\mathbf{F}}$	25	mA	
Operating Temperature	Topr	-40 ~ +85	°C	
Storage Temperature	Tstg	-40 ~ +90	°C	
Electrostatic Discharge(HBM)	ESD	2000	V	
Power Dissipation	Pd	60	mW	
Peak Forward Current (Duty 1/10 @1KHz)	IFP	60	mA	
Soldering Temperature	Tsol	Reflow Soldering : 260 $^{\circ}$ C for 10 sec. Hand Soldering : 350 $^{\circ}$ C for 3 sec.		

Electro-Optical Characteristics (Ta=25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition	
Luminous Intensity	Iv	11.5		28.5	mcd		
Peak Wavelength	λp		568		nm		
Dominant Wavelength	λd	563.5		571.5	nm		
Spectrum Radiation Bandwidth	$ riangle \lambda$		20		nm	$I_F = 20 m A$	
Viewing Angle	2 <i>θ</i> 1/2		130		deg		
Forward Voltage	VF	1.75		2.35	V		
Reverse Current	Ir			10	μA	V _R =5V	

Notes:

1.Tolerance of Luminous Intensity ±10%

2.Tolerance of Dominant Wavelength ±1nm

3.Tolerance of Forward Voltage ±0.1V

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Bin Range Of Dom. Wavelength

Group	Bin	Min	Max	Unit	Condition	
Α	C13	563.5	565.5			
	C14	565.5	567.5		I _F =20mA	
	C15	567.5	569.5	nm		
	C16	569.5	571.5			

Bin Range Of Luminous Intensity

Bin	Min	Max	Unit	Condition
L	11.5	18.0	1	I _F =20mA
М	18.0	28.5	mcd	

Bin Range Of Luminous Voltage

Group	Bin	Min	Max	Unit	Condition	
В	0	1.75	1.95			
	1	1.95	2.15	V	$I_F = 20 m A$	
	2	2.15	2.35			

Notes:

1.Tolerance of Luminous Intensity ±10%

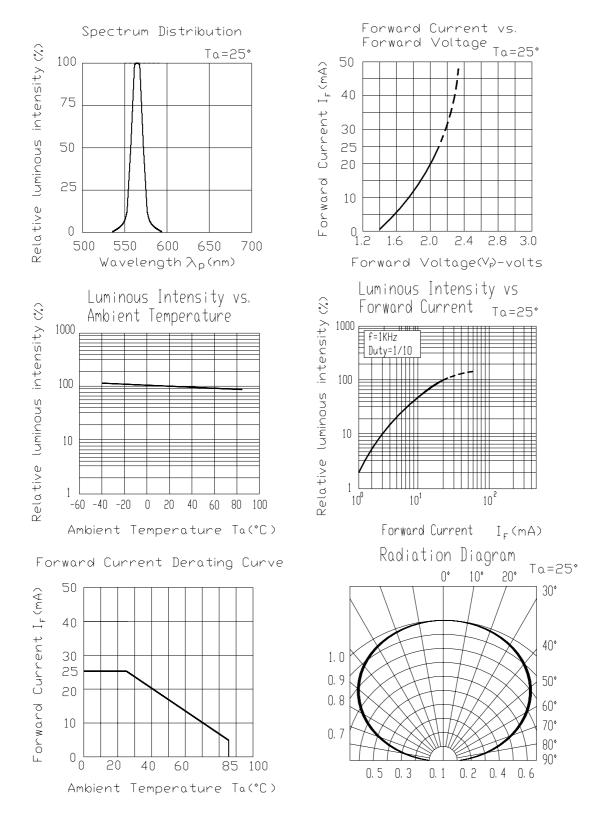
2.Tolerance of Dominant Wavelength ±1nm

3.Tolerance of Forward Voltage ±0.1V

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Typical Electro-Optical Characteristics Curves

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Everlight Electronics Co., Ltd. Device No:SZDSE-175-G08

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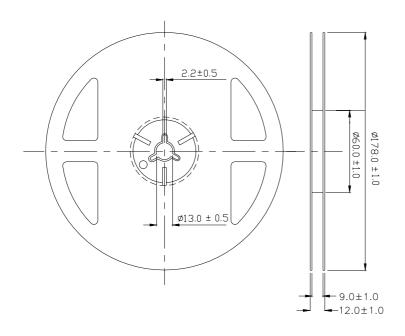
Label explanation

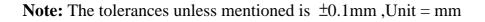
CAT: Luminous Intensity Rank

- HUE: Dom. Wavelength Rank
- **REF: Forward Voltage Rank**



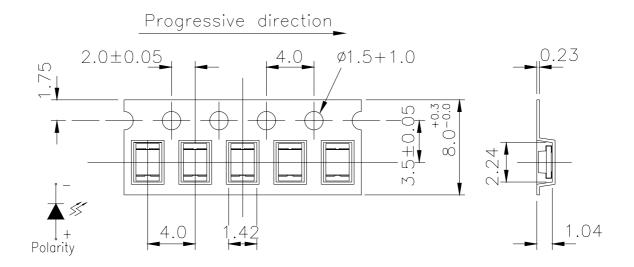
Reel Dimensions





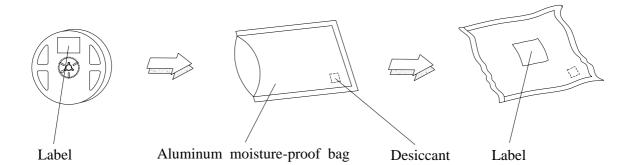
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Carrier Tape Dimensions: Loaded quantity 3000 PCS per reel



Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm

Moisture Resistant Packaging





17-215/GVC-ALMB/3T

Reliability Test Items And Conditions

The reliability of products shall be satisfied with items listed below. Confidence level : 90%

LTPD: 10%

No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Re
1	Reflow Soldering	Temp. : 260°C ±5°C Min. 5sec.	6 Min.	22 PCS.	0/1
2	Temperature Cycle	H : +100°C 15min $\int 5 \text{ min}$ L : -40°C 15min	300 Cycles	22 PCS.	0/1
3	Thermal Shock	H: +100°C 5min $\int 10 \sec$ L: -10°C 5min	300 Cycles	22 PCS.	0/1
4	High Temperature Storage	Temp. : 100°C	1000 Hrs.	22 PCS.	0/1
5	Low Temperature Storage	Temp. : -40°℃	1000 Hrs.	22 PCS.	0/1
6	DC Operating Life	$I_F = 20 \text{ mA}$	1000 Hrs.	22 PCS.	0/1
7	High Temperature / High Humidity	85°C/85% RH	1000 Hrs.	22 PCS.	0/1

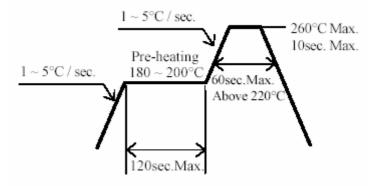
17-215/GVC-ALMB/3T

Precautions For Use

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

- 2. Storage
 - 2.1 Do not open moisture proof bag before the products are ready to use.
 - 2.2 Before opening the package, the LEDs should be kept at 30° C or less and 90%RH or less.
 - 2.3 The LEDs should be used within a year.
 - 2.4 After opening the package, the LEDs should be kept at 30° C or less and 60%RH or less.
 - 2.5 The LEDs should be used within 168 hours (7 days) after opening the package.
 - 2.6 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.Baking treatment : 60±5°C for 24 hours.
- 3. Soldering Condition
- 3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

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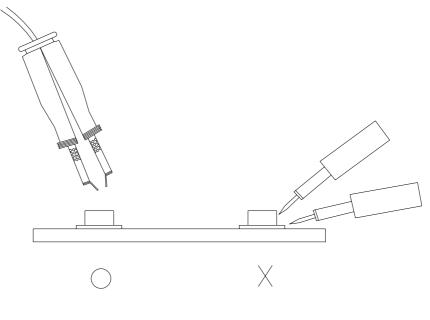
17-215/GVC-ALMB/3T

4.Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350° C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



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